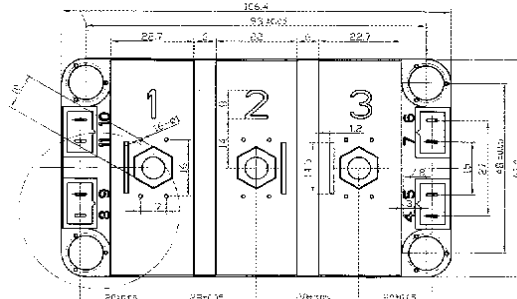
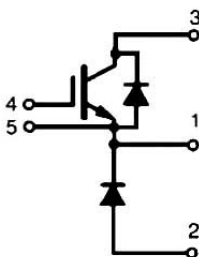
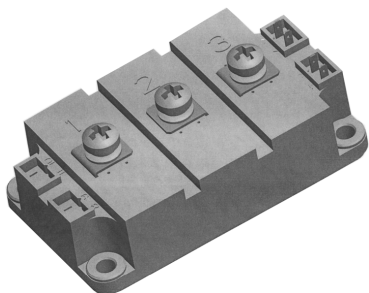


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SPT IGBT Modules

Dimensions in mm (1mm = 0.0394")



Absolute Maximum Ratings

$T_c = 25^{\circ}\text{C}$, unless otherwise specified

Symbol	Conditions	Values	Units
IGBT			
V_{CES}		1200	V
I_C	$T_c = 25(80)^{\circ}\text{C}$	370(265)	A
I_{CRM}	$T_c = 25(80)^{\circ}\text{C}$, $t_P = 1\text{ms}$	740(530)	A
V_{GES}		± 20	V
$T_{Vj}, (T_{stg})$	$T_{OPERATION} \leq T_{stg}$	$-40 \dots +150(125)$	$^{\circ}\text{C}$
V_{isol}	AC, 1min	4000	V
Inverse Diode			
$I_F = -I_C$	$T_c = 25(80)^{\circ}\text{C}$	260(180)	A
I_{FRM}	$T_c = 25(80)^{\circ}\text{C}$, $t_P = 1\text{ms}$	690(500)	A
I_{FSM}	$t_P = 10\text{ms}$; sin.; $T_j = 150^{\circ}\text{C}$	1800	A
Freewheeling diode			
$I_F = -I_C$	$T_c = 25(80)^{\circ}\text{C}$	260(180)	A
I_{FRM}	$T_c = 25(80)^{\circ}\text{C}$, $t_P = 1\text{ms}$	690(500)	A
I_{FSM}	$t_P = 10\text{ms}$; sin.; $T_j = 150^{\circ}\text{C}$	1800	A

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SPT IGBT Modules

Characteristics

T_c = 25°C, unless otherwise specified

Symbol	Conditions	min.	typ.	max.	Units
IGBT					
V _{GE(th)}	V _{GE} = V _{CE} , I _c = 8mA	4.5	5.5	6.5	V
I _{CES}	V _{GE} = 0; V _{CE} = V _{CE(s)} ; T _j = 25(125)°C		0.2	0.6	mA
V _{CE(TO)}	T _j = 25°C		1(0.9)	1.15(1.05)	V
r _{CE}	V _{GE} = 15V, T _j = 25(125)°C		4.5(6)	6(7.5)	mΩ
V _{CE(sat)}	I _c = 200A; V _{GE} = 15V; chip level		1.9(2.1)	2.35(2.55)	V
C _{ies}	under following conditions		17		
C _{oes}	V _{GE} = 0, V _{CE} = 25V, f = 1MHz		2		nF
C _{res}			1.9		
L _{CE}				20	nH
R _{CC'+EE'}	res., terminal-chip T _c = 25(125)°C		0.35(0.5)		mΩ
t _{d(on)}	under following conditions: V _{CC} = 600V, I _c = 200A		170		ns
t _r	R _{Gon} = R _{Goff} = 5 Ω, T _j = 125°C		55		ns
t _{d(off)}	V _{GE} = ± 15V		660		ns
t _f			60		ns
E _{on} (E _{off})			22(22)		mJ
Inverse Diode under following conditions:					
V _F = V _{EC}	I _F = 200A; V _{GE} = 0V; T _j = 25(125)°C		2(1.8)	2.5	V
V _(TO)	T _j = 25(125)°C		1.1	1.2	V
r _T	T _j = 25(125)°C		4.5	6.5	mΩ
I _{RRM}	I _F = 200A; T _j = 125°C		280		A
Q _{rr}	di/dt = 6300A/us		33		uC
E _{rr}	V _{GE} = V		11		mJ
FWD under following conditions:					
V _F = V _{EC}	I _F = 100A; V _{GE} = 0V; T _j = 25(125)°C		2.1(1.8)	2.5	V
V _(TO)	T _j = 25(125)°C		1.1	1.2	V
r _T	T _j = 25(125)°C		4.5	6.5	mΩ
I _{RRM}	I _F = 200A; T _j = 25(125)°C		280		A
Q _{rr}	di/dt = A/us		33		uC
E _{rr}	V _{GE} = V		11		mJ
Thermal Characteristics					
R _{th(j-c)}	per IGBT			0.085	K/W
R _{th(j-c)D}	per Inverse Diode			0.18	K/W
R _{th(c-s)}	per module			0.038	K/W
Mechanical Data					
M _s	to heatsink M6	3		5	Nm
M _t	to terminals M6	2.5		5	Nm
w				325	g